2.5 V/3.3 V 3.0 GHz Differential 1:4 LVPECL Fanout Buffer

Multi-Level Inputs with Internal Termination

Description

The NB6L14 is a 3.0 GHz differential 1:4 LVPECL clock or data fanout buffer. The differential inputs incorporate internal 50 Ω termination resistors that are accessed through the VT pin. This feature allows the NB6L14 to accept various logic standards, such as LVPECL, LVCMOS, LVTTL, CML, or LVDS logic levels. The VREF_AC reference output can be used to rebias capacitor–coupled differential or single–ended input signals. The 1:4 fanout design was optimized for low output skew applications.

The NB6L14 is a member of the ECLinPS MAX[™] family of high performance clock and data management products.

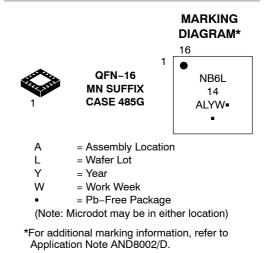
Features

- Input Clock Frequency > 3.0 GHz
- Input Data Rate > 2.5 Gb/s
- < 20 ps Within Device Output Skew
- 350 ps Typical Propagation Delay
- 150 ps Typical Rise and Fall Times
- Differential LVPECL Outputs, 700 mV Amplitude, Typical
- LVPECL Mode Operating Range: V_{CC} = 2.375 V to 3.63 V with GND = 0 V
- Internal 50 Ω Input Termination Resistors Provided
- VREF_AC Reference Output Voltage
- -40°C to +85°C Ambient Operating Temperature
- Available in 3 mm x 3 mm 16 Pin QFN
- These are Pb-Free Devices



ON Semiconductor®

http://onsemi.com



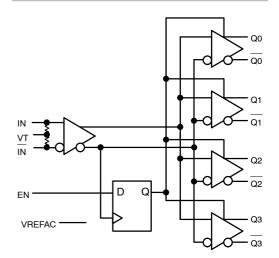


Figure 1. Simplified Logic Diagram

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

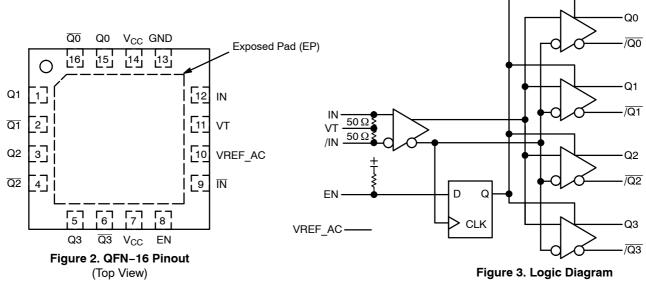


Table 1. EN TRUTH TABLE

IN	ĪN	EN	Q0:Q3	Q0:Q3
0	1	1	0	1
1	0	1	1	0
х	х	0	0+	1+

+ = On next negative transition of the input signal (IN).

x = Don't care.

Table 2. PIN DESCRIPTION

Pin	Name	I/O	Description
1	Q1	LVPECL Output	Non–inverted Differential Output. Typically Terminated with 50 Ω Resistor to V_CC–2.0 V.
2	<u>Q1</u>	LVPECL Output	Inverted Differential Output. Typically Terminated with 50 Ω Resistor to V _{CC} – 2.0 V.
3	Q2	LVPECL Output	Non–inverted Differential Output. Typically Terminated with 50 Ω Resistor to V_{CC} – 2.0 V.
4	Q2	LVPECL Output	Inverted Differential Output. Typically Terminated with 50 Ω Resistor to V _{CC} – 2.0 V.
5	Q3	LVPECL Output	Non-inverted Differential Output. Typically Terminated with 50 Ω Resistor to $V_{CC}-2.0$ V.
6	<u>Q3</u>	LVPECL Output	Inverted Differential Output. Typically Terminated with 50 Ω Resistor to V _{CC} – 2.0 V.
7	V _{CC}	-	Positive Supply Voltage
8	EN	LVTTL/LVCMOS	Synchronous Output Enable. When LOW, Q outputs will go LOW and \overline{Q} outputs will go HIGH on the next negative transition of IN input. The internal DFF register is clocked on the falling edge of IN input (see Figure 20). The EN pin has an internal pullup resistor and defaults HIGH when left open.
9	ĪN	LVPECL, CML, LVDS, HSTL	Inverted Differential Clock Input. Internal 50 Ω Resistor to Termination Pin, VT.
10	VREF_AC		Output Voltage Reference for capacitor-coupled inputs, only.
11	VT		Internal 100 Ω center-tapped Termination Pin for IN and \overline{IN} .
12	IN	LVPECL, CML, LVDS, HSTL	Non-inverted Differential Clock Input. Internal 50 Ω Resistor to Termination Pin, VT.
13	GND	-	Negative Supply Voltage
14	V _{CC}	-	Positive Supply Voltage
15	Q0	LVPECL Output	Noninverted Differential Output. Typically Terminated with 50 Ω Resistor to V_CC=2.0 V.
16	<u>Q0</u>	LVPECL Output	Inverted Differential Output. Typically Terminated with 50 Ω Resistor to V _{CC} =2.0 V.
-	EP	-	The Exposed Pad (EP) on the QFN-16 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat-sinking conduit. The pad is not electrically connected to the die, but is recommended to be electrically and thermally connected to GND on the PC board.

1. In the differential configuration when the input termination pin VT, is connected to a common termination voltage or left open, and if no signal is applied on IN/IN inputs, then the device will be susceptible to self-oscillation.

Table 3. ATTRIBUTES

Characterist	Characteristics						
ESD Protection	Human Body Model Machine Model	> 4 kV > 100 V					
Moisture Sensitivity (Note 2)	QFN-16	Level 1					
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in					
Transistor Count		167					
Meets or exceeds JEDEC Spec EIA	Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test						

2. For additional information, see Application Note AND8003/D.

Table 4. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	Positive Power Supply	GND = 0 V		4.0	V
V _{lo}	Positive Input/Output	GND = 0 V	$-0.5~\textrm{V} \leq \textrm{V}_{\textrm{IO}} \leq \textrm{V}_{\textrm{CC}} + 0.5~\textrm{V}$	4.0	V
I _{IN}	Input Current Source or Sink Current (IN/IN)			±50	mA
I _{VREF_AC}	Source or Sink Current on VT Pin			±2.0	mA
I _{OUT}	Output Current	Continuous Surge		50 100	mA mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			–65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient) (Note 3)	0 lfpm 500 lfpm	QFN-16 QFN-16	42 35	°C/W °C/W
θJC	Thermal Resistance (Junction-to-Case)	(Note 3)	QFN-16	4	°C/W
T _{sol}	Wave Solder Pb-Free			265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

3. JEDEC standard multilayer board - 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

Table 5. DC CHARACTERISTICS, Multi-Level Inputs, LVPECL Outputs

 V_{CC} = 2.375 V to 3.63 V, GND = 0 V, T_A = $-40^\circ C$ to +85°C

Symbol	Characteristic	Min	Тур	Max	Unit		
I _{CC}	Power Supply Current (Inputs and Outputs Open)	35	47	65	mA		
LVPECL OUTPUT DC ELECTRICAL CHARACTERISTICS							
V _{OH}	Output HIGH Voltage (Notes 4 and 5) (Q, \overline{Q})	V _{CC} - 1145	V _{CC} – 1020	V _{CC} - 895	mV		

	V _{CC} = 3.3 V V _{CC} = 2.5 V	2155 1355	2280 1480	2405 1605	
V _{OL}	Output LOW Voltage (Notes 4 and 5) (Q, $\overline{Q})$ $\begin{array}{c} V_{CC} = 3.3 \ V \\ V_{CC} = 2.5 \ V \end{array}$	V _{CC} – 1945 1355 555	V _{CC} – 1875 1475 675	V _{CC} – 1695 1605 805	mV

DIFFERENTIAL INPUT DRIVEN SINGLE-ENDED (See Figures 10 and 11)

V _{th}	Input Threshold Reference Voltage Range (Note 6)	1100	V _{CC} – 100	mV
V _{IH}	Single-Ended Input High Voltage	V _{th} + 100	V _{CC}	mV
V _{IL}	Single-Ended Input LOW Voltage	GND	V _{th} – 100	mV
V _{ISE}	Single-Ended Input Voltage Amplitude ($V_{IH} - V_{IL}$)	200	V _{CC} – GND	mV

VREFAC						
V _{REFAC}	Output Reference Voltage (V_{CC} \ge 2.5 V)	V _{CC} - 1.525	V _{CC} – 1.425	V _{CC} – 1.325	mV	

V _{IHD}	Differential Input HIGH Voltage	1200	V _{CC}	mV
V _{ILD}	Differential Input LOW Voltage	GND	V _{IHD} – 100	mV
V _{CMR}	Input Common Mode Range (Differential Configuration) (Note 8)	950	V _{CC} – 50	mV
V _{ID}	Differential Input Voltage (IN-IN) (VIHD-VILD)	100	V _{CC} – GND	mV
IIH	Input HIGH Current IN/IN (VT Open)	-150	+150	μΑ
IIL	Input LOW Current IN/IN (VT Open)	-150	+150	μΑ

LVTTL/LVCMOS INPUT DC ELECTRICAL CHARACTERISTICS

V _{IH}	Input HIGH Voltage	2.0	V _{CC}	V
V _{IL}	Input LOW Voltage	GND	0.8	V
I _{IH}	Input HIGH Current, $V_{CC} = V_{IN} = 3.63 V$	-10	50	μΑ
IIL	Input LOW Current, V_{CC} = 3.63 V, V_{IN} = 0 V	-150	0	μΑ

TERMINATION RESISTORS

R _{TIN}	Internal Input Termination Resistor (IN to VT)	40	50	60	Ω
R _{DIFF_IN}	Differential Input Resistance (IN to IN)	80	100	120	Ω

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

4. LVPECL outputs loaded with 50 Ω to V_{CC} – 2.0 V for proper operation.

5. Input and output parameters vary 1:1 with V_{CC} .

6. Vth is applied to the complementary input when operating in single-ended mode.

 V_{IHD}, V_{ILD}, V_{ID} and V_{CMR} parameters must be complied with simultaneously.
V_{CMR} min varies 1:1 with GND, V_{CMR} max varies 1:1 with V_{CC}. The V_{CMR} range is referenced to the most positive side of the differential input signal.

Symbol	Characteristic	Min	Тур	Max	Unit
V _{OUTPP}	Output Voltage Amplitude (@ V _{INPPmin}) (Note 10) $f_{IN} \le 1.25 \text{ GHz}$ $1.25 \text{ GHz} \le f_{in} \le 2.0 \text{ GHz}$ $2.0 \text{ GHz} \le f_{in} \le 3.0 \text{ GHz}$	550 380 250	700 500 320		mV
f _{DATA}	Maximum Operating Data Rate		2.5		Gb/s
t _{PD}	Propagation Delay IN to Q	250	370	500	ps
t _S	Set–Up Time (Note 11) EN to IN, TN	300			ps
t _H	Hold Time (Note 11) EN to IN, TN	300			ps
t _{SKEW}	Within-Device Skew (Note 12) Device to Device Skew (Note 13)		5.0	20 150	ps
UITTER	$\begin{array}{l} \mbox{RMS Random Jitter (Note 14)} & f_{IN} = 2.5 \mbox{ GHz} \\ \mbox{Peak-to-Peak Data Dependent Jitter} & f_{DATA} = 2.5 \mbox{ Gb/s} \end{array}$		14	1.0	ps
V _{INPP}	Input Voltage Swing/Sensitivity (Differential Configuration) (Note 10)	100		V _{CC} – GND	mV
t _r ,t _f	Output Rise/Fall Times @ Full Output Swing (20%-80%)	70	150	200	ps

Table 6. AC CHARACTERISTICS V_{CC}	= 2.375 V to 3.63 V, GND = 0 V,	$T_A = -40^{\circ}C$ to $+85^{\circ}C$ (Note 9)
--------------------------------------	---------------------------------	-------------------------------------------------

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

Measured by forcing V_{INPP} (min) from a 50% duty cycle clock source. All loading with an external R_L = 50 Ω to V_{CC} - 2.0 V. Input edge rates 40 ps (20%-80%).

10. Input and output voltage swing is a single-ended measurement operating in differential mode.

11. Set-up and hold times apply to synchronous applications that intend to enable/disable before the next clock cycle. For asynchronous applications, set-up and hold times do not apply.

12. Within device skew is measured between two different outputs under identical power supply, temperature and input conditions.

13. Device to device skew is measured between outputs under identical transition @ 0.5 GHz.

14. Additive RMS jitter with 50% duty cycle clock signal.

15. Additive peak-to-peak data dependent jitter with input NRZ data at PRBS 2²³-1 and K28.5 at 2.5Gb/s.

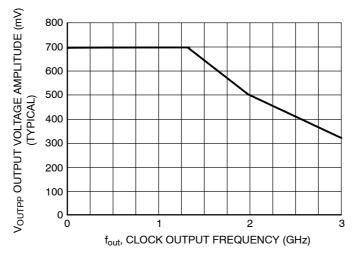
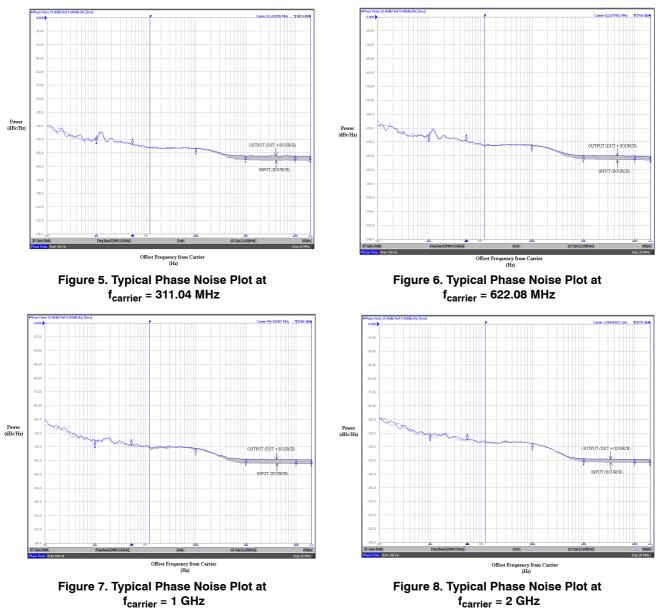


Figure 4. Output Voltage Amplitude (V_{OUTPP}) versus Output Frequency at Ambient Temperature (Typical)



f_{carrier} = 1 GHz

The above phase noise plots captured using Agilent E5052A show additive phase noise of the NB6L14 device at frequencies 311.04 MHz, 622.08 MHz, 1 GHz and 2 GHz respectively at an operating voltage of 3.3 V in room temperature. The RMS Phase Jitter contributed by the

device (integrated between 12 kHz and 20 MHz; as shown in the shaded region of the plot) at each of the frequencies is 27 fs, 17 fs, 13 fs and 5 fs respectively. The input source used for the phase noise measurements is Agilent E8663B.

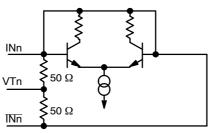
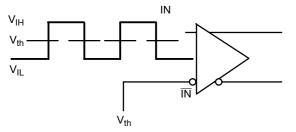
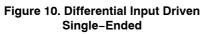


Figure 9. Input Structure





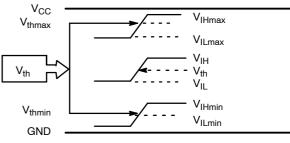


Figure 11. V_{th} Diagram

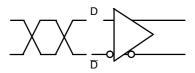


Figure 12. Differential Inputs Driven Differentially

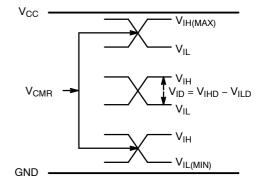


Figure 13. V_{CMR} Diagram

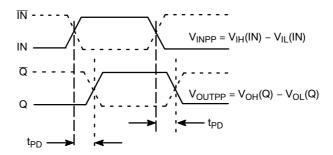


Figure 14. AC Reference Measurement

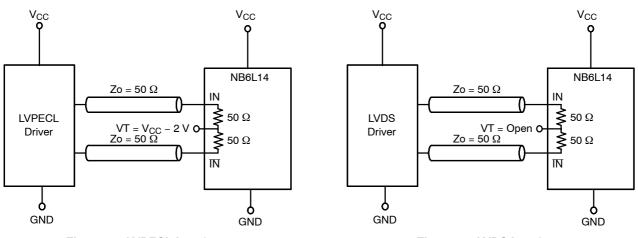
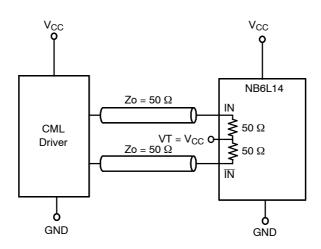
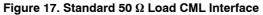
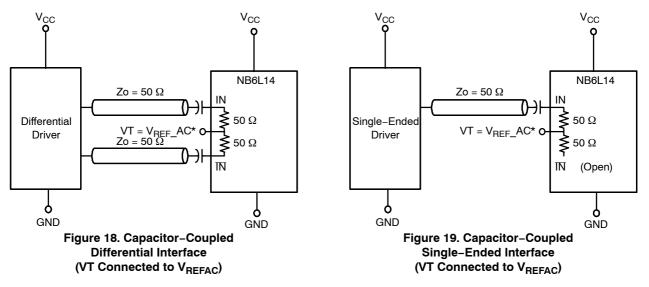




Figure 16. LVDS Interface







*V_{REFAC} bypassed to ground with a 0.01 μF capacitor

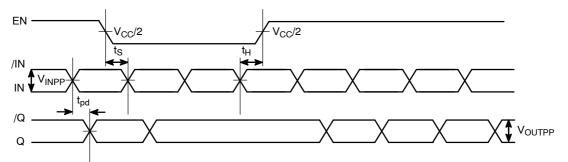


Figure 20. EN Timing Diagram

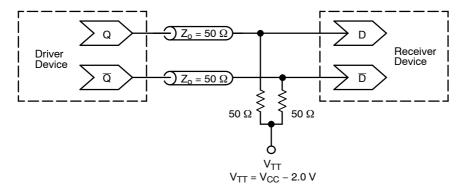


Figure 21. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices.)

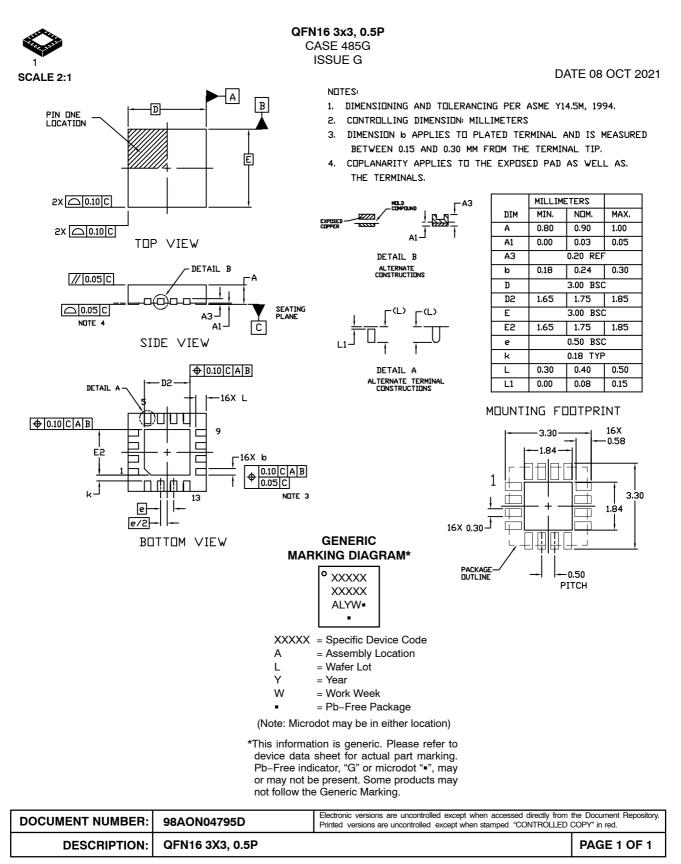
ORDERING INFORMATION

Device	Package	Shipping [†]
NB6L14MNG	QFN-16, 3x3 mm (Pb-Free)	123 Units / Rail
NB6L14MNR2G	QFN-16, 3x3 mm (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ECLinPS MAX is a trademark of Semiconductor Components Industries, LLC (SCILLC).

onsemi



onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patter rights nor the rights of others.

onsemi, ONSEMI., and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclorating, or solication of use products for any particular purpose, not occes of series assume any maturing ansing on series of the application of use of any product or circuit, and specifically disclorations any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others, onsemi products are not designed, intended, or authorized for use as a critical component in life support systems. or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application, Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death Associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

٥